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Realistic Adhesion Test for Photovoltaic Modules Qualification

Jiang Zhu, Dan Wu, Daniel Montiel-Chicharro, Thomas R. Betts, and Ralph Gottschalg

Abstract—Adhesion requirements for photovoltaic modules to ensure reliability are often discussed but not well defined, neither in terms of tests nor actual requirements. This paper presents a new approach for realistic assessment of the adhesion strength, which shows the conventional peel test may not ensure reliability. The test presented reproduces the actual adhesion requirements for fielded modules much more closely than the commonly used peel testing. The test is conducted in situ during standard damp-heat test at a temperature of 85 °C and 85% relative humidity, with the modules installed at an angle to give an appropriate force vector perpendicular to the backsheet. This is achieved by attaching weights to the back of the tested samples which are mounted with a 45° angle on a testing rack in the environmental cabinet. With an appropriate weight setup, this could be done as part of the standard damp-heat cycle during certification and would not involve additional testing time nor significant changes in the commonly used racking. This approach will identify the weakest interface of the multilayer encapsulation system. A number of test-to-fail bespoke samples are tested to set realistic fail criteria. It is shown that the test allows discrimination between different samples and can identify unsuitable production processes.

Index Terms—Adhesion, backsheet, certification, damp-heat, delamination, EVA, in situ, peel, qualification.

I. INTRODUCTION

The reliability and durability of photovoltaic (PV) modules is the key to the financial success of any PV installation. PV modules rely on packaging materials to provide extended protection for solar cells and electrical circuitry against various operating environments in order to maintain long service life. Delamination is a major failure mode as, e.g., SolarWorld showed that over 90% of the modules returned have delamination-related failures [1] and there is no reason to believe that this is limited to the particular manufacturers. The prevalence of this failure mode also demonstrates that current certification practice is not sufficient to capture this issue. The peel test currently being used for qualifying modules designs clearly is not stringent enough. In Section II, the reasons for this are discussed.

The typical module structure for c-Si wafer-based modules is shown in Fig. 1. It uses a structural element (front glass layer), two layers of encapsulant which sandwich the active materials and a polymeric multilayer backsheet. These layers are bonded together in a laminator and framed. The different layers are bonded adhesively to each other during the lamination process. The quality of encapsulation depends on the adhesion strength at these interfaces as well as the cohesive strength of the material.

II. WHY IS DELAMINATION NOT IDENTIFIED IN CERTIFICATION?

Current certification tests employ a peel test. The force employed is either 90° or 180° (T-peel). Neither test reproduces realistic conditions as the fracture initiation will be different in reality as there is no shear stress there. Modules are currently being tested in environmental chambers in vertical racks, where delamination could be initiated, for example, by the weight of the junction box. This clearly is not happening as otherwise this would be reported by test houses as a significant failure mode. The potential reasons could be that the fracture initiation is inhibited by the frame which is clamping the backsheet in place and no pull force is placed on the module. In reality, the module is installed at an angle and thus a mixture of shear and pull forces are present as shown in Fig. 2. The potential for movement in the sheer direction is limited due to the frame but the force will be present in terms of fracture initiation. Thus, the hypothesis of this paper that a combination of pull and shear forces is required and a successful test will present both to the module.

Further reasons why failures are not commonly observed in certification testing is that adhesion testing is carried out on virgin modules (i.e., unstressed) and close to room temperature.

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Modules regularly experience temperatures in excess of 60 °C, which are above the glass transition temperatures of the most common encapsulants (EVA). Thus, the material is in a very different state when being tested in the laboratory to the real stress conditions in the field. This is critical as not only different adhesion values are obtained but also, as shown below, different failure modes may be dominant.

The differences in the forces in play and the different material state result in a lack of clarity of the adhesion strength required for fielded modules.

III. Adhesion Requirements for PV Modules

A. Delamination and Adhesion

In order to avoid delamination, a minimum adhesion between different layers is required for PV modules. For EVA encapsulated modules that are tested in this study, adhesion at the EVA and backsheet interface \((f_{EB})\) is influenced by the primer or coupling agents added at the inner side of the backsheet. These enhance the adhesion by either forming chemical bonds or increasing physical adsorption. The inner side of the backsheet is often another layer of EVA. This allows the molecules of the two EVA layers to diffuse into each other and thus allows the backsheet manufacturer to control the adhesion of backsheet to EVA. The adhesion between EVA and glass \((f_{GE})\) is normally provided by thermally activated adhesion promoters \([2]–[4]\). The promoters are normally in the form of silane coupling agents, which are used to enhance adhesion by forming silicon–oxygen covalent bonds \([5]\). While the state of this is not measured directly, the gel content is still a secondary indicator as both depend strongly on the thermal history of the lamination. The backsheet of PV modules are typically multiple layers of polymers, which are bonded together with adhesives. The adhesive in between backsheet sublayers is not accessible, but could be influenced by lamination as well. Delamination may occur at the backsheet sublayers due to the degradation of adhesives \((f_{BS})\). Consequently, observed failures were both adhesive and cohesive depending on which interface or bulk material is the weakest one.

The adhesion requirements for reliable operation are not well understood. Failures of packaging material at interfaces of glass to encapsulant, encapsulant to backsheet, and backsheet sublayers will be investigated as these are the commonly observed failures of fielded PV modules \([6]–[10]\) for module types that passed certification. This may be due to failure potential not being recognized in the certification test or that production modules have a variation in lamination conditions, which is known to have a significant impact on adhesion strength and retention \([11]\).

B. Issue of Variation in Lamination Temperature

Adhesion strength at different interfaces is influenced by material properties and lamination conditions. Most material manufacturers have standard “recipes” for the lamination process, which should be closely followed to ensure durability of the product. Deviations are possible in production and this may induce a potential for delamination. Deviations are common as these can be introduced by relatively minor variations in lamination temperatures. The quality of lamination is often defined by the gel content in the encapsulant and commercially the shortest pathway to achieve the specified minimum gel content is used. This often means the highest possible temperature is chosen, where it is likely to “overshoot” and introduce negative impacts. The other extreme is manufacturers using older equipment, which sometimes may, unbeknown to themselves, not reach the specified temperatures. Therefore, variations in temperature are possible, which can directly influence adhesive strength and thus lead to differences in delamination potential. Tests are needed to distinguish between these and sieve out process conditions with increased delamination potential.

C. Issue of Material Condition Under Test

Adhesion deterioration that leads to failure of packaging materials is one of the crucial ageing mechanisms for PV modules. In the PV community, the peel test is widely used to characterize interfacial adhesions between glass and EVA or flexible backsheet and EVA \([12]–[14]\). The test is normally carried out at room condition to investigate the relative change of interfacial adhesion before and after aging. The result of adhesion tests strongly depend on the testing condition, including temperature, as e.g., elasticity of EVA is temperature dependent \([15]\). This is important for PV devices, where adhesion tests are carried out at room temperature but devices see much higher temperatures during operation. In maritime climates, such as the U.K., modules reach regularly in excess of 60 °C \([16]\), while roof-integrated modules can reach 95 °C \([17]\). Mechanical stresses which may cause adhesion failure, e.g., the weight of junction box, unsupported cables, or cables being pulled, will be experienced at elevated temperature.

The above indicates that the stresses as well as the testing need to be carried out closer to the conditions of operation. The level of stress to be applied is not as obvious and will be investigated in the following paper. The overall stress level or the required adhesion strength is not easily defined. The requirements set today are for as produced modules. During normal operation, the adhesion strength can be reduced to less than 10% of its initial values. Thus, tests should be conducted on the aged material.

IV. Development of a Novel Test

To address the points above, it is suggested to use a test that can be implemented during “normal” certification tests as this would minimize additional testing effort. It also has the added
advantage that stressing is carried out during expected aging conditions. Thus, the suggestion is to use the standard damp-heat (DH) test, where PV modules are exposed to a relative humidity of 85\% at a temperature of 85 °C for a testing period of 1000+ hours.

The test developed in this paper is to investigate delamination of the backsheet (or other layers), not adhesion of the junction box or other components. Thus, it is suggested to attach a weight to the back of the backsheet delivering a specified weight. This can be achieved by means of gluing to the backsheet, with glue that maintains adhesion strength greater than that of the mechanical stresses applied. An approximation of realistic force direction (pull against shear) can be achieved by putting the modules at an angle into the environmental chamber (see Fig. 3). This may present a problem for test houses, where modules are mounted vertically in the chamber. Other approaches where similar force distributions are achieved are possible, but for the sake of simplicity the angled-mounting strategy is used here. The angle suggested is 45° simply because it applies shear and pull forces in equal measures. The angle is somewhat steeper than what the majority of modules will see, as large power systems will be typically installed around 20° inclination. However, domestic roof top installations will be in this range and thus the suggested inclination is not unreasonable.

Various weights are attached to the back of the devices under test (DUT) in this study in order to determine stress levels required. The stress needs to be sufficient to discriminate between good and bad samples without creating too many false negatives. The DUT is considered to have failed the test if any sagging of the weight is observed or any delamination is observed.

In order to validate this test, and to identify appropriate stress levels, the experiment reported below was conducted.

V. EXPERIMENTAL DESIGN AND VALIDATION OF TEST APPROACH

Bespoke samples were produced in-house at Centre for Renewable Energy Systems Technology (CREST), presenting a wide range of production conditions. The test is carried out on a small area, representative samples, simply for the sake of the number of samples to be tested simultaneously. This allows multiple stress levels and various module lamination conditions to be tested. A test to fail is carried out to identify appropriate stress levels.

Sample size is 12.5 by 20 cm with a glass-EVA-solar cell-EVA-backsheet structure. No frames or sealants were used. All the materials are commercially available from the PV industry and widely used in the industry, but details cannot be released due to confidentiality. The glass front layer is 2.9 mm thick float glass. A fast cure EVA of a thickness of 460 μm is used as an encapsulant. The backsheet is a tri-layer insulating polymer consisting of PET/PET/primer layer. The solar cells used are 1.8 W mc-Si cells. These mini-modules were prepared under different lamination temperatures at 125, 135, 140, 145, and 150 °C with constant curing time of 10 min. This introduces some conditions which are outside the production window and thus delivers some samples that should fail this test. These samples are referred to in the following as L125, L135, L140, L145, and L150, respectively. The measured gel content of the L125 samples was around 60\%–70\%, which was the lowest. The gel content increases with the increasing lamination temperature and reached 91\% for L150 samples. All these samples are within specifications set for acceptable gel contents by the industry [18], albeit L125 is borderline.

The backsheet of each mini-module was prepared 5 cm longer than the module’s length to enable easy attachment of a weight. Rather than gluing to the back, the actual weight was hung at the top part of the backsheet as shown in the left picture of Fig. 3. Different weights of 250 g, 500 g, and 1 kg were used to stress the backsheet adhesion. For some samples, the top part of backsheet was cut into narrow strips of 1 or 2 cm wide for testing. This initial cut significantly increased the force per unit width, which was expected to lead to different failures. All the samples were mounted on a testing frame with 45° tilted angle. This setup was then placed in an environmental chamber operating at 85 °C/85%RH. The test is a 135° peel test, which is close to conditions seen in the field. All samples were subjected to test to fail. The time when the delamination occurred was recorded for each sample and used as an indicator of the quality of module packaging.

The gravity test is to investigate the adhesion failures at the weakest interface of packaging materials under stressed condition that modules may encounter during the operation of their lifetime. The melting point of EVA is around 60–70 °C, which means the EVA may be in different phases at room condition and at operating temperature [19]. This increases the likelihood of different failures being identified by the two testing approaches, i.e., the peel test and the gravity test. The other difference between these two approaches is that the gravity test is a constant load testing, i.e., peeling at a constant force, whereas the peel test is a constant displacement testing, i.e., peeling at a constant rate. These differences demonstrate that the presented test is closer to realistic conditions than the peel test used in the laboratory. A summary of number of samples for each lamination condition that tested under different stress condition is given in Table I. At least two samples were tested for one condition in order to ensure the reproducibility of the test.

VI. RESULTS OF TRIAL RUNS

A. Observed Failure Categories

The weakest interface of the packaging material changes over time, which leads to different failure modes at different stress
levels and times. Depending on the weight applied to backsheet, different failure modes were observed.

Fig. 4 shows the observed four different types of failures of module packaging during the gravity test. Type A failure is delamination of backsheet sublayers. Type B failure is delamination at the interface between glass and EVA. Type C failure is delamination at the interface between EVA and backsheet. Type D failure is a mix of Type A and Type B that delamination occurred at multiple layers including backsheet sublayer and between EVA and glass.

All tested samples delaminated eventually, except for the L140 sample with 20 g/cm force which did not fail after 1800 h exposure. The observed delamination categories and times are summarized in Tables II and III, respectively.

L125 samples demonstrated from Type C delamination for all weights from 20 to 1000 g/cm within 2 h of testing. This is due to the low curing temperature not being sufficient to achieve diffusion of EVA and the EVA compatible material in the inner side of backsheet. Therefore, the EVA/backsheet interface remains the weakest interface.

For lamination temperature higher than 135 °C, no Type C delamination was observed. Type B failure was seen by L135 to L150 samples tested with a weight of 80 g/cm. All failures occurred within 10 h of testing, indicating that the load is too heavy and is creating unrealistically short failure rates. Furthermore, the adhesion between glass and EVA was lower than that between EVA and backsheet. Type B failure was seen by L135 and L140 samples, which are around the manufacturer’s recommended optimum lamination temperature, saw Type A failure only.

The time-to-fail also demonstrates a good ability to discriminate between good and bad laminations. The “good” laminations L135, L140, and L145 all survived the standard 1000 hours DH test. Thus, the recommendation is to add this weight during DH testing, ensuring that both pull and sheer forces around

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<th>TABLE I</th>
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<tr>
<td><strong>NUMBER OF SAMPLES FOR GRAVITY TEST</strong></td>
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<tr>
<td>20 g/cm</td>
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<td>L125</td>
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<th>TABLE II</th>
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<tr>
<td><strong>SUMMARY OF FAILURE CATEGORIES FOR GRAVITY TEST</strong></td>
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<td>20 g/cm</td>
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<th>TABLE III</th>
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<tr>
<td><strong>SUMMARY OF DELAMINATION TIME (HOURS)</strong></td>
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<td>20 g/cm</td>
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<td>L125</td>
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10–20 g/cm are present. As an aside, this indicates that adding weights equivalent to 5N onto the junction box as currently being discussed to test the adhesion of the junction box, may inadvertently introduce a delamination in dependence of where the weights are attached and if a pull force is exerted.

B. Comparison With Peel Test

The gravity test outcomes are compared with the standard peel test. It is shown that the outcomes are more realistic.

A different set of L125, L135, and L145 samples was subjected to DH exposure at 85 °C/85%RH for up to 1500 h. Samples were removed from exposure after 500, 1000, and 1500 h and tested for 90° peel strength test with a crosshead speed of 50 mm/min as described in [20]. Failure modes observed in peel tests conducted at room are summarized in Table IV. Although all the samples were prepared with the peeling interface at the glass/EVA interface, the L125 samples saw initial Type C failure between EVA and backsheet due to low mutual diffusion of EVA molecules. This changed to a mix of Type B and C failures after 500 h aging. The L135 and L145 samples saw Type B failure at glass/EVA interface at initial stage (0–500 h) and the failure shifted to the EVA/backsheet interface as samples aged. The pattern of failure modes summarized in Table III is different from the ones observed for the gravity test as shown in Table II. The peel test cannot test the adhesion at backsheet sublayers.

Fig. 5 plots the measured peel strength values against exposure time by peel tests together with the gravity test result of samples’ time-to-failure (exposure time) with their corresponding weights (20 g/cm) as the second Y-axis. L140 sample did not fail after 1800 h exposure, which is plotted in the brackets. The required peel strength decreases with the increasing exposure time. Looking at the L125-P and L125-G result, the gravity test was performed at a higher temperature and saw L125 samples failed quickly. In contrast, the peel test was performed at room temperature and L125 samples showed good durability in terms of adhesion. L125 is outside the permissible production window for a reason as modules are unlikely to have a reliable encapsulation and are likely to have delamination. Thus, these samples should not pass delamination tests and peel tests result might be misleading. This demonstrates that the proposed test is better at discriminating and identifying samples with delamination potential.

Peel tests show a rapid degradation in the early stages of DH exposure. The absolute difference between the different samples is relatively low with the results being within measurement uncertainty. At least that is the most likely interpretation of the increase of peel test adhesion for the 1500 h data point of the L145. The in situ gravimetric test seems to give more useful information as it allows a measurable distinction between the different conditions.

VII. Conclusion

The current certification tests do not appropriately pick up delamination while this is something seen in the field. This paper presented and verified that delamination is currently assessed by means of peel testing at conditions that are different than those seen during module operation. An in situ gravimetric test is developed that more reliably identifies potential delamination risks. It is shown that observed failures match those seen in reality much closer than the conventional T-peel test.

The gravimetric test applies a mix of shear and pull forces to a module’s backsheet during standard damp-heat testing. Selecting appropriate weights allows an assessment as part of the conventional 1000 h damp-heat test. Failure is defined as delamination during the damp-heat test. In this paper, an identified appropriate stress level would be to attach a weight of 20 g/cm to the backsheet with an equal distribution of pull and shear stresses. This is not too dissimilar to what would be expected from forces being applied by some junction boxes.

Clearly, there is potential to optimize this test further. However, it is shown that inappropriate lamination conditions will be identified by this test and thus the suggested test allows differentiation between reliable models and those at risk of delamination.

The suggested test would not add further tests in a certification cycle as it could be conducted in conjunction with certification tests commonly being done. Thus, at virtually no additional cost or effort, the risk of installations to delaminate can be reduced drastically.

REFERENCES


Authors’ photographs and biographies not available at the time of publication.